Layer	Name	Material	Thickness
	Silkscreen top (white)		
	Soldermask top (blue)	SM-003	0,025mm
1	L1	CF-006	0,105mm
	Dielectric1	High Tg prepreg (e.g. Panasonic R-1650V)	0,200mm
2	L2	CF-006	0,105mm
	Dielectric 3	High Tg prepreg (e.g. Panasonic R-1650V)	0,200mm
3	L3	CF-004	0,105mm
	Dielectric 2	High Tg prepreg (e.g. Panasonic R-1650V)	0,200mm
4	L4	CF-004	0,105mm
	Dielectric 4	High Tg prepreg (e.g. Panasonic R-1650V)	0,200mm
5	L5	CF-006	0,105mm
	Dielectric 5	High Tg prepreg (e.g. Panasonic R-1650V)	0,200mm
6	L6	CF-006	0,105mm
	Soldermask bottom (blue)	SM-003	0,025mm
	Silkscreen bottom (white)		

Total board thickness: 1,681mm

Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad	Comment
○	8	0,850mm (33,47mil)	PTH	Round	L1 - L6	Pad	
□	1	1,200mm (47,24mil)	PTH	Slot	L1 - L6	Pad	
✡	7	1,200mm (47,24mil)	PTH	Slot	L1 - L6	Pad	
▽	4007	0,300mm (11,81mil)	PTH	Round	L1 - L6	Via	Epoxy filled + 20um Cu capping
	4023 Total						

Slot definitions : Routed Path Length = Calculated from tool start centre position to tool end centre position.
Hole Length = Routed Path Length + Tool Size = Slot length as defined in the PCB layout

